

**SUPPLEMENTAL RESPONSE UNDER 37 C.F.R. § 1.111(a)(2)  
EXAMINING GROUP 1765**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Application of : K.R. Udayakumar et al. Confirmation No.: 8320  
Application Number : 10/721,932  
Filed : November 25, 2003  
Title : METHOD FOR ETCHING A SUBSTRATE AND A DEVICE  
FORMED USING THE METHOD  
TC/Art Unit : 1765  
Examiner: : Lan VINH  
Docket No. : TI-35507 (0025.0203)  
Customer No. : **23494**

**MAIL STOP AMENDMENT**  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

**SUPPLEMENTAL AMENDMENT**

Pursuant to an Interview which took place with the Examiner on January 3, 2008, and pursuant to the provisions of 37 C.F.R. 1.111(a)(2), the following Supplemental Amendments and Remarks are provided at the request of the Examiner and to place the application into condition for allowance. Please further amend the application as follows:

**Current Claims** are reflected in the listing of claims in this paper beginning at page 2.

**Remarks** begin at page 7.